

The 67thJSAP Spring Meeting 2020

Dates: March 12(Thu.)-15(Sun.), 2020

Venue: Yotsuya Campus, Sophia University

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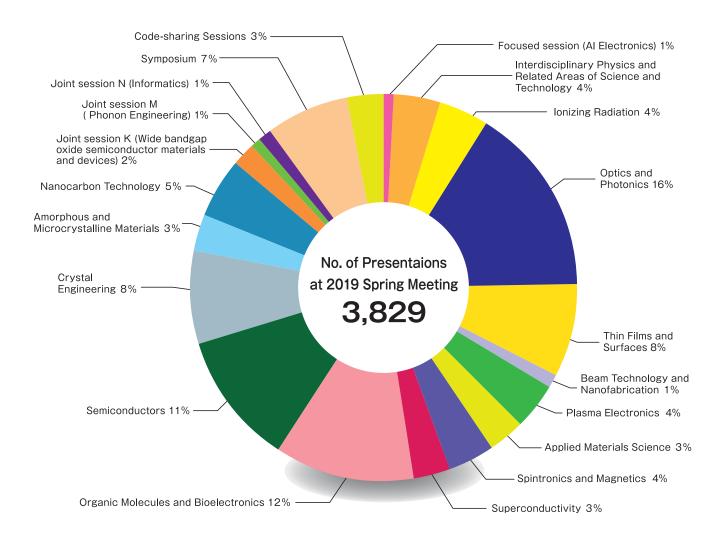


Sponsored by The Japan Society of Applied Physics Operational Management by Nikkan Kogyo Communications

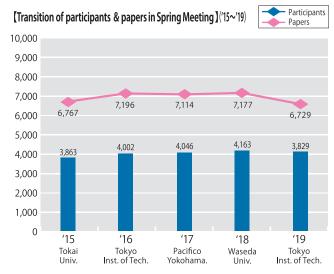


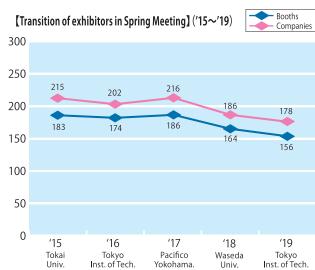
About The Japan Society of Applied Physics

JSAP has more than 20,000 members and there are approximately 4,000 presentations on latest research at every JSAP annual meeting.



About JSAP Spring Meetings & EXPO





About JSAP EXPO

JSAP EXPO Spring 2020(The 67th JSAP Spring Meeting 2020) Location: Gymnasium and Active Commons, Sophia University

Exhibit Hours

March 12(Thu.) March 13(Fri.) -- 9:30am-6:00pm March 14(Sat.) March 15(Sun.)— 9:30am-12:00noon

Installation

March 11(Wed.) 2:00pm-7:00pm March 12(Thu.) 8:30am-9:30am

3 spotlights

Dismantling March 15(Sun.) 12:00noon-3:00pm

Booth Packages and Pricings

ApplicationDeadline:January 29(Wed.), 2020

 JSAP Corporate Members/ Advertiser of JSAP membership journal "OYO BUTURI": 230,000 JPY

2 Standard: 250.000 JPY

3 Publisher Booth: 150,000 JPY

Booths Specifications

Type A Booth W1980 x D990 x H2400

[includes; company sign, back and side wall (no side wall for the corner booths.), 1 display table (W1800 X D900 X H730), 1 chair, 1 lighting (40W)]

Type B Booth (W3000×D2000) [includes; carpeting and 1 chair]

Publisher Booth W1980×D990×H2400

[includes; company sign, back wall, 1 display table (W1800 X D900 X H730),

1 chair, 2 spotlights]

Optional Selection Items and Pricing

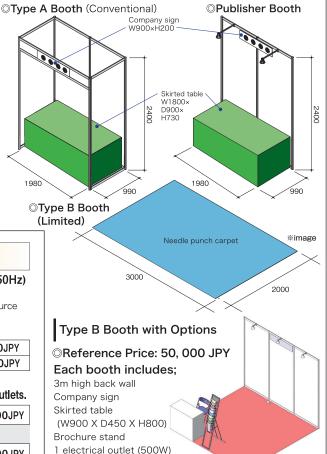
Additional Electricity Supply and Pricing (AC Single-Phase 100V 50Hz)

- ※ The list price includes wiring costs.
- * If you prefer single-phase 200V or three-phase, additional fees for power source construction are needed.
- ※ Consult if you need power supply with breaker.

1W- 500W	10,000JPY	501W- 1000W	15,000JPY
1001W- 2000W	25,000JPY	2001W- 3000W	35,000JPY

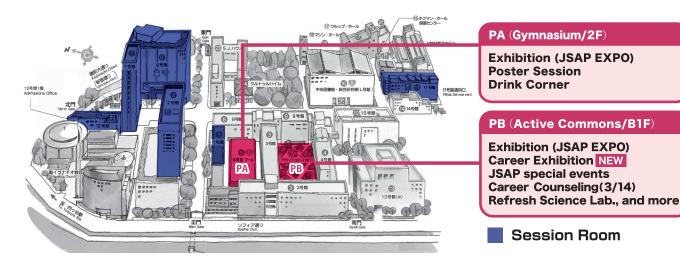
For more than 3001W, 10,000 JPY will be charged per 1000W. If you order additional electricity, you need to order additional electrical outlets.

2 Electrical Outlets (750W) *including wiring	3,500JPY		
Other Options (Consult if you need unlisted options.)			
LED Spotlights *including electrical wiring	4,500JPY		



Venue Map

Brochure Stand (12 holders)



7.500JPY

*image

JSAP EXPO Spring&Autumn 2019, Exhibitors List

AD Science Inc.

AdvanceSoft Corporation

Al Electronics Ltd.

AIST

AIST-NPF

ALD Japan, Inc.

ANSeeN Inc.

Anton Paar Japan K.K.

AOV Co., Ltd.

APEX/ JJAP Editorial Division, JSAP

APF, Inc.

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TOSHIBA NANOANALYSIS

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Symposium Sponsor NEW!

Symposium Sponsorship Prospectus

Sympopsium Sponsor can place a banner ad for their products and technologies on the web program. The sponsors can use a table outside the session room. To display their brochures.

PLAN1 100,000JPY

Company logo including clickable link on a web program page, flyer/brochures distribution in the session room.

PLAN2 200,000JPY (Limited1company/symposium)

Short presentation(15 min.) at the end of the symposium. Company logo including clickable link on a web program page, flyer/brochuce distribution in the session room.

No.	Category / Title	Date
NT-1	*open to public Development of emerging talent in applied physics through diversity promotion – what JSAP can/should do –	Mar. 13 (Fri.)
NT-2	*open to public 就活生必見!車は半導体でできている! ~車載半導体の未来と最先端研究者の「やりがい」~※English title TBA	Mar. 13 (Fri.)
NT-3	*open to public To accelerate social implementations of applied-physic technologies related to integrated circuits	Mar. 14 (Sat.)
T-1	Focused Session "Al Electronics" *open to public Emerging devices, architectures and systems for the post-Moore's Law era	Mar. 13 (Fri.)
T-2	1. Interdisciplinary Physics and Related Areas of Science and Technology Realization, Learning, Environment and Energy	Mar. 14 (Sat.)
T-3	2. Ionizing Radiation Recent Advances in Radioisotope Imaging Technology for Plant Science Research	Mar. 13 (Fri.)
T-4	3.Optics and Photonics New developments in computing technique based on optical neural network	Mar. 12 (Thu.)
T-5	3.Optics and Photonics Research progress on laser induced periodic surface structure "What has been revealed? How about the technology outlook?	Mar. 13 (Fri.)
T-6	3.Optics and Photonics Applied physics for quantum computer developments	Mar. 13 (Fri.)
T-7	3.Optics and Photonics Fundamental and applications of spatial light modulation	Mar. 14 (Sat.)
T-8	3.Optics and Photonics /9.Applied Materials Science Nano-Materials Science for MIR-THz photonics	Mar. 14 (Sat.)
T-9	3.Optics and Photonics Disturbance of light propagating the fluctuating media: The way how to measure and overcome it	Mar. 15 (Sun.)
T-10	6.Thin Films and Surfaces Leading edge of all-solid-state batteries: Basics, challenges, and future prospects	Mar. 13 (Fri.)
T-11	6.Thin Films and Surfaces New developments of surface properties and structural analysis by quantum beams	Mar. 13 (Fri.)
T-12	6.Thin Films and Surfaces New functional memory devices with oxide material and its physics	Mar. 14 (Sat.)
T-13	6.Thin Films and Surfaces/12.Organic Molecules and Bioelectronics The fusion of multidimensional measurement technologies and data science toward the advancement of bioimaging and biosensing	Mar. 14 (Sat.)
T-14	7.Beam Technology and Nanofabrication Quantum-beam study of optical functions in transition-metal-compound thin films	Mar. 13 (Fri.)
T-15	7.Beam Technology and Nanofabrication Progresses and future on EUV and soft x-ray imaging techniques	Mar. 14 (Sat.)
T-16	8.Plasma Electronics Forefront of elucidating the mechanism of plasma-induced biological reactions	Mar. 13 (Fri.)
T-17	9.Applied Materials Science Science of Ensemble Phenomenon~Emergence of Novel Functions and Applications by Harmonization of Complex-States~	Mar. 14 (Sat.)
T-18	9.Applied Materials Science Future developments on energy storage devices~For improvement of capacitance and reliability~	Mar. 13 (Fri.)
T-19	9.Applied Materials Science/Joint Session M "Phonon Engineering" Pitfalls in thermoelectric measurements	Mar. 13 (Fri.)
T-20	10.Spintronics and Magnetics Frontier of Nonvolatile Memory technologies - Spintronic, Phase-change, Resistive and Ferroelectric-	Mar. 13 (Fri.)
T-21	11.Superconductivity Sensing technology realized by superconductor - Recent applications of SQUID-	Mar. 14 (Sat.)
T-22	12. Organic Molecules and Bioelectronics Organic Transistors: Exploring New Frontiers	Mar. 14 (Sat.)
T-23	13. Semiconductors Development of multinary compounds based on engineering for diverse stable phases -Future Materials Exploring Initiative~Future of Environment and Energy Materials~	Mar. 12 (Thu.)
T-24	13. Semiconductors IoT devices and technologies in production fields	Mar. 12 (Thu.)
T-25	13. Semiconductors Recent progress in Advanced Ion Microscopy: Application to nano materials and devices	Mar. 13 (Fri.)
T-26	15.Crystal Engineering Materials Science and Advanced Electronics Created by Singularity of Nitride Semiconductors -Frontiers in defect physics: Merging characterization and theory-	Mar. 12 (Thu.)
T-27	15.Crystal Engineering Nano-cybernetics of interface bonded at room or low temperature and ultra thin films at heterojunction interface	Mar. 14 (Sat.)
T-28	16.Amorphous and Microcrystalline Materials Advances of Energy Harvesting Technologies for Society 5.0	Mar. 13 (Fri.)
T-29	16.Amorphous and Microcrystalline Materials Current topics and future prospects of amorphous materials and their device applications	Mar. 13 (Fri.)
T-30	16.Amorphous and Microcrystalline Materials Toward construction of academic theory on "module science" with giving cases of solar cells	Mar. 14 (Sat.)
T-31	17.Nanocarbon Technology Science of integrated two-dimensional materials	Mar. 13 (Fri.)

Luncheon Seminar

Luncheon Sponsorship Prospectus

40 minutes luncheon seminars at the session room during the lunch time

Scenes from Luncheon Seminars













▲Scenes from the luncheon seminars at 2019 Spring Meeting.

Dates and Hours: Seminar Contents

Fees *The cost for lunch boxes is not included.

Dates and Hours: March 12(Thu.)-14(Sat.), 2020 12:00~

**Lunch time varies by session.

Sponsors can decide the contents of the seminar.

e.g.) company PR (40 minutes) invited lecture (30 minutes) + company's product or technology PR (10 minutes)

Room Capacity		100 people	80 people
Exhibitors	Standard	160,000JPY	124,000JPY
EXHIBITORS	JSAP Corporate Members	140,000JPY	104,000JPY
Non-	Standard	230,000JPY	194,000JPY
Exhibitors	JSAP Corporate Members	210,000JPY	174,000JPY

Benefits

Complimentary meeting registration with extended abstracts DVD and official guidebook * 1 registration for 1 slot

Luncheon seminar flyers will be published on all of the below.

①Official Website

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②Extended Abstracts DVD (4 color/ 1P)



③Conference App (iPad, iPhone,



④Facebook
(@jsapexpo)



⑤Twitter (@jsapexpo)



©Online Conference Program



Session Room Sponsorship Prospectus

Session room sponsors can exclusively set the ads for their products and technologies, or the announcements of international conferences as a desktop wallpaper on the session room PC. Wallpapers will be displayed during the change of speakers, the rest breaks and the lunch breaks. The sponsors can also display posters inside the session room and use a brochure stand outside the session room.

Dates and Hours

Dates: March 12(Thu.)-15(Sun.), 2020

Hours: $9:00 \sim 18:30$

*The start and end time varies by session. *The rest breaks are 15-30 minutes long

(one in the morning, one in the afternoon) and lunch break is 60-90 minutes long.

Fees

Exhibitors/JSAP Corporate Member/ Advertiser of JSAP membership journal		1 Room (4 Days)	100,000JPY	
	Standard	1 Room (4 Days)	150,000JPY	

How to Apply

Conference Program Open: early Feb.



Application Deadline: Feb. 21(Fri.)



Wallpaper Data Submission Deadline: Mar. 6(Fri.)

Conference program will be posted on the official website.

Session schedule by room will be sent in early Feb.

Please submit a wallpaper data to the secretariat. * Specifications will be announced after the application.

Onsite Operations

Please send the brochures and posters by Mar. 6(Fri.) to Nikkan Kogyo Communications, Inc. or bring directly to the venue on Mar. 11 (Wed.)

- · JSAP staff will set the wallpaper on the session room PC.
- · 2 sets of brochure stands will be provided at the session room.









How to Apply

Please e-mail (expo@nikkanad.co.jp) or FAX (+81-3-5614-3011) a completed form. Apply early to secure your preferred room.

Program Advertising

The Official Guidebook! (Conference program)



80.000JPY

Enclosed with the March Issue of OYOBUTURI and distributed at the meeting venue!!

Contents

- Conference program (Latest Edition)
- Presenter index
- Exhibition information
- Events information

2018年 第79回応用物理学业款季季消腾消金 The 79° JSAP Autumn Meeting, 2018
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General information

Circulation: 17,000

(all members) +participants

Date of issue : March 10 (Tue), 2020

Application deadline : January 31 (Fri.), 2020

Manuscript deadline : February 10 (Mon.), 2020

Manuscript size : A4 sheet

only to 2 space

only to 2 space

Space & Color	Exhibitor / JSAP Corporate Member Advertiser of JSAP membership Journal	Standard
Back 4 cover	330,000JPY	350,000JPY
Inside 4 cover	270,000JPY	280,000JPY
Inside back 4 cover	240,000JPY	250,000JPY
Front page 4 color	250,000JPY	260,000JPY
Front page B&W	125,000JPY	135,000JPY
Back page B&W	105,000JPY	115,000JPY
1/2Page Horizontal	90,000JPY	100,000JPY

70.000JPY

- + Both formats of Macintosh and Windows, text display data, outlined text data, image and PDF files are desirable.
- + Image file types: EPS file is best possible, and TIFF, JPEG, GIFF are acceptable.
- + Resolution: 350 dpi or over
- + Process colors: Cyan, Magenta, Yellow, Black Process colors:*RGB method (Red, Green, Blue) is unacceptable.

Banner Ads

Reach participants by advertising on the conference website, web program and mobile app.







Fee

1/3Page Horizontal

Web Program



App (iOS, Android)

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Location	Size (pixel)	Display	Fee Exhibitor/ISAP	0	Duration	The number	Application
		formats	Exhiibitor/JSAP Corporate Memeber	Standard		of places	Deadline
1. Official W	lebsite NE	W!					
Top page	W280xH100	PNG,JPEG,GIF	150,000JPY	200,000JPY	*	4	Jan. 29(Wed.), 2020
2. App (iOS	2. App (iOS, Android)						
Top page	W1536xH210	PNG	50,000JPY	100,000JPY	*	3	Jan. 29(Wed.), 2020
3. Web Prog	3. Web Program						
Top page	W160 x H100	PNG,JPEG,GIF	150,000JPY	200,000JPY	*	6	
Category	W160 x H100	PNG,JPEG,GIF	100,000JPY	150,000JPY	*	64	Feb. 21(Fri.), 2020
Section	W160 x H100	PNG,JPEG,GIF	20,000JPY	30,000JPY	*	106	

[Contact] JSAP EXPO and Sponsorship Sales

* 2 months prior to the meeting until the sponsor's removal request



Nikkan Kogyo Communications, Inc.

No.3 Kayabacho Nagaoka building, 2-7-10, Nihonbashi-Kayabacho Chuo-ku, Tokyo 103-0025 JAPAN

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The 67th JSAP Spring Meeting 2020

- Yotsuya Campus, Sophia University

Company Information						
Company						
Person in charge						
Address				TEL : FAX :		
Contact Person	Department	Name		E-mail: TEL:		
Web Address				Emergency Contact Number:		
Exhibition Details						
* Booth		Corporate Members / Advertiser of JSAP pership Journal "OYO BUTURI"	250,000 J 230,000 J er 150,000 J	PY x () unit =	PPY JPY	
Electricity				() W =	JPY	
Electric outlets			3,50	0 JPY × () =	JPY	
LED Spotlights			4,50	0 JPY x () =	JPY	
Brochure stand			7,50	0 JPY x () =	JPY	
			Total		JPY	
Payment Due Date ▶ ▶ Please complete the payment by wire transfer by Friday, February 28, 2020. Remarks;						
Products Field (Choose a field for one products) 1. Vacuum instruments 5. Analytical instruments 8. Chiller 9. Software one products) 1. Vacuum instruments 6. Thin-film deposition systems 7. Electrical measuring equipment and power source 10. Molecular Electronics and Bioelectronics 11. Books 12. Al Electronics 13. Other (
Venue (Choose a venue for PA or PB)	(Choose a venue for (Exhibition Poster Sersion Driph Corpor)					
Your Exhibit Items						
Offer giveaway to JSAP stamp rally	☐ Yes (Goods:	Qty:) 🗆		ompany logo display end your company lo	to on a Lottery corner. go (JPEG)	
	Signature; Date; The undersigned hereby authorizes Nikkan Kogyo Communications, Inc. to reserve exhibit space for use by this company during the JSAP EXPO Spring 2020 as indicated and agrees to abide by the Rules and Regulations governing each respective Exposition.					

Send Application to; Nikkan Kogyo Communications, Inc.

FAX. +81-3-5614-3011 or E-mail. shirane@nikkanad.co.jp

